

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YAO-WEN BAI	04/01/2011
RECEIVING PARTY DATA	
Name:	Hong Heng Sheng Electronical Technology (HuaiAn)Co.,Ltd
Street Address:	No.168,Foxconn Road,Economic Development Area
City:	Huai An City, Jiangsu Province
State/Country:	CHINA
Name:	FOXCONN ADVANCED TECHNOLOGY INC.
Street Address:	No. 6, Lane 28, San Ho Rd., San Shi Village
City:	Tayuan, Taoyuan
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13087390
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Total Attachments: 2 source=US34241110414ASM#page1.tif source=US34241110414ASM#page2.tif	

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PATENT
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| 1. | <u>YAO-WEN BAI</u> | , residing at | <u>Huai An, Jiangsu Province, China</u> |
| 2. | <u></u> | , residing at | <u></u> |
| 3. | <u></u> | , residing at | <u></u> |
| 4. | <u></u> | , residing at | <u></u> |
| 5. | <u></u> | , residing at | <u></u> |
| 6. | <u></u> | , residing at | <u></u> |

hereby sell(s), assign(s) and transfer(s) unto: **HONG HENG SHENG ELECTRONICAL TECHNOLOGY (HUAIAN)CO.,LTD** having a principal place of business at No.168, Foxconn Road, Economic Development Area, Huai An City, Jiangsu Province, P.R.C. and **FOXCONN ADVANCED TECHNOLOGY INC.** having a principal place of business at No. 6, Lane 28, San Ho Rd., San Shi Village, Tayuan, Taoyuan, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **ETCHING DEVICE AND METHOD FOR MANUFACTURING PRINTED CIRCUIT BOARD USING SAME** for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
 [x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

